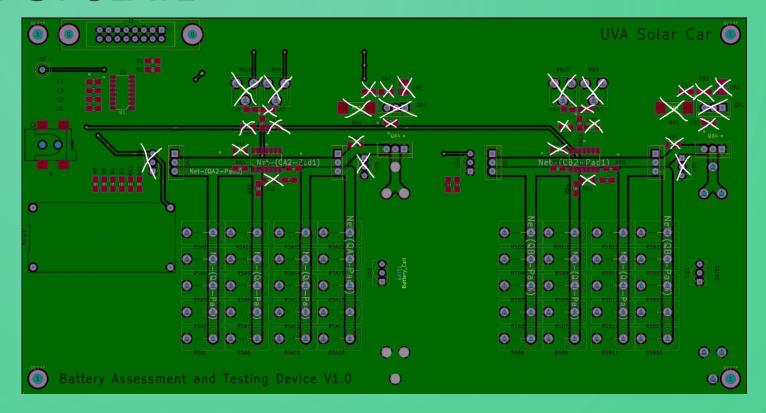


#### WHAT **NOT** TO POPULATE

- UA1, UA4, UA5
- DA1 DA5
- CA1 CA4
- RA1, RA2, RA9, RA10
- QA1
- UB1, UB4, UB5
- DB1 DB5
- CB1 CB4
- RB1, RB2, RB9, RB10
- QB1

Why?

These slots were designated for hardware over-temperature and over-voltage protection. They were expensive to populate, and the same protection can be done through software. Other crossed off slots are for battery charging, which will be implemented externally.



#### SOLDERING COMPONENTS: 12 STEPS

- 1. Through hole resistors
- 2. Surface mount resistors
- 3. Capacitors
- 4. Op Amps
- 5. Analog to Digital Converter (ADC) 11. MOSFETS
- 6. Wire Housing

- 7. Chip Select Pin
- 8. Buck Converter
- 9. Battery Contacts
- 10. Temperature Sensors
- 12. DC Power Jack

#### STEP 1: THROUGH HOLE RESISTORS

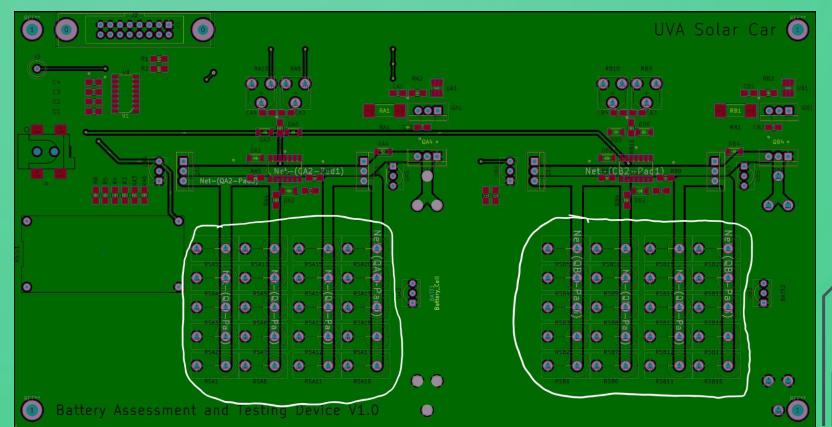
- RSA1 RSA20
- RSB1 RSB20

40 Total

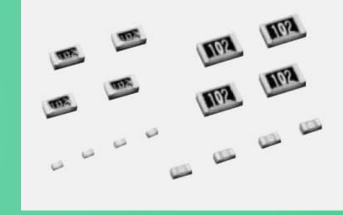


0.6W, 10Ω

(All images link to product pages)







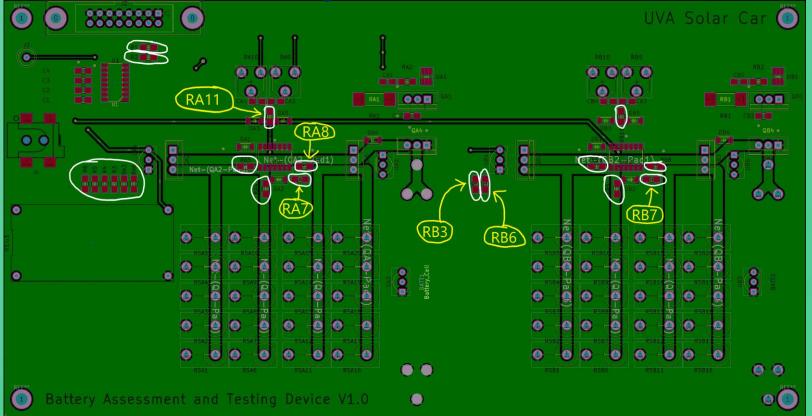
- R1 R6
- RA3 RA8, RA11
- RB3 RB8, RB11

20 Total

Note:

RA11 and RB11 are supposed to be  $10k\Omega$ , but we will be using

 $47k\Omega$  resistors for the time being



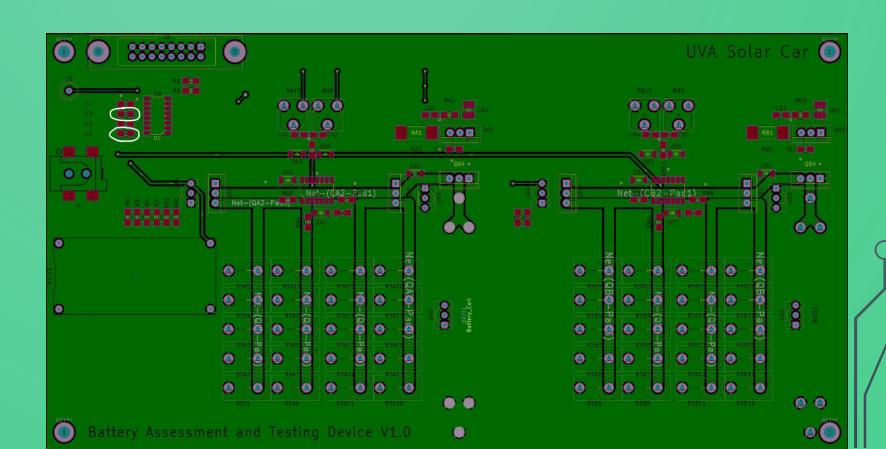
0.0625W, 47kΩ

#### STEP 3A: SURFACE MOUNT CAPACITORS



10µF

• C1, C3

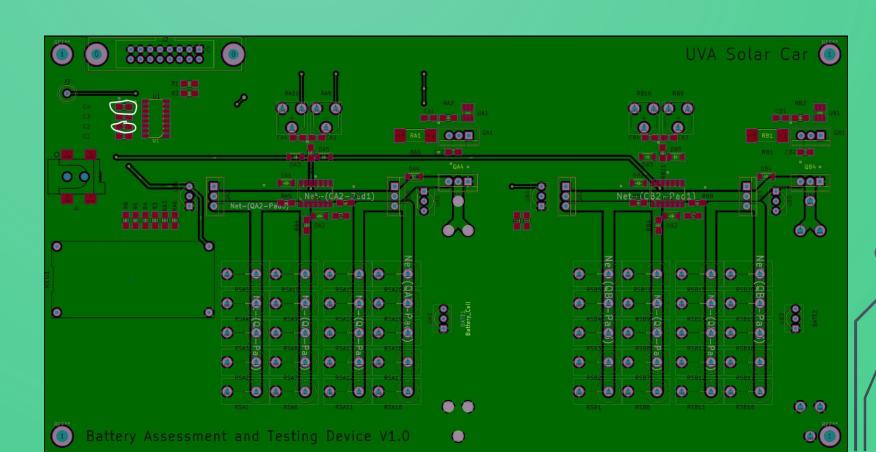


## STEP 3B: SURFACE MOUNT CAPACITORS

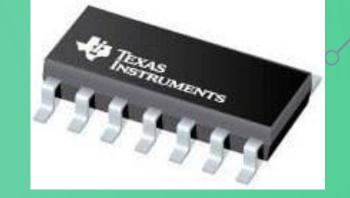


0.1 µF

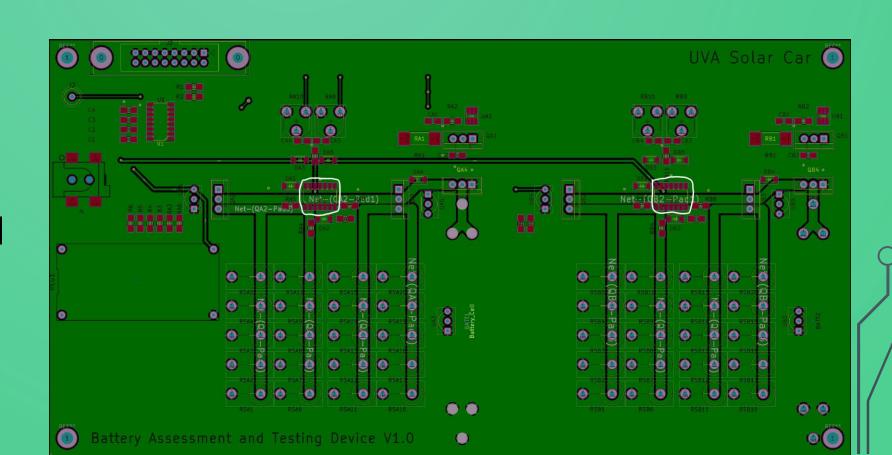
• C2, C4







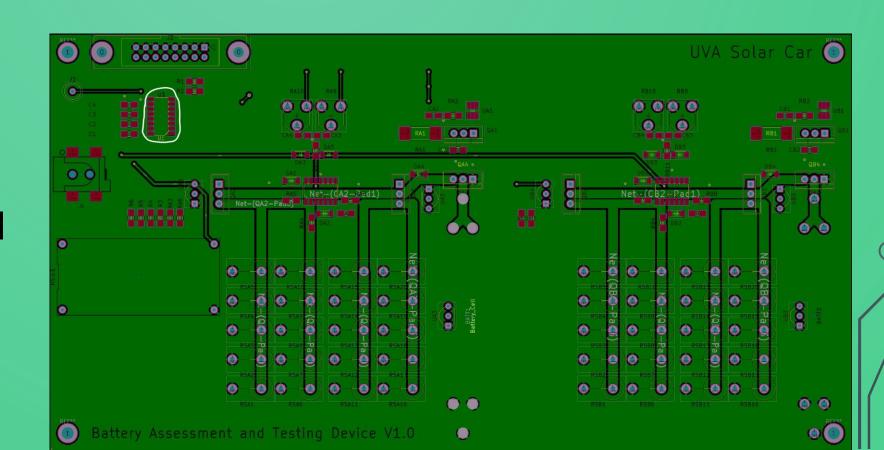
- UA2
- UB2



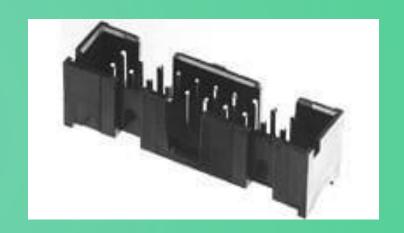
# STEP 5: ANALOG TO DIGITAL CONVERTER (ADC)



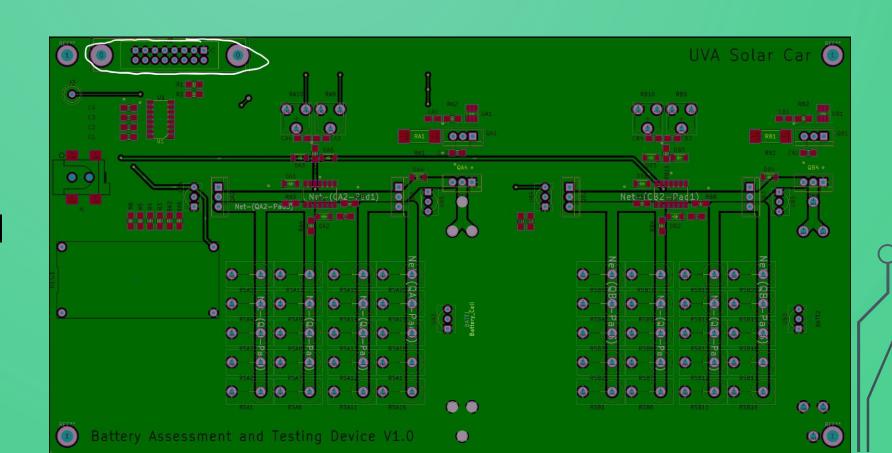
U1



# STEP 6: WIRE HOUSING



• J2

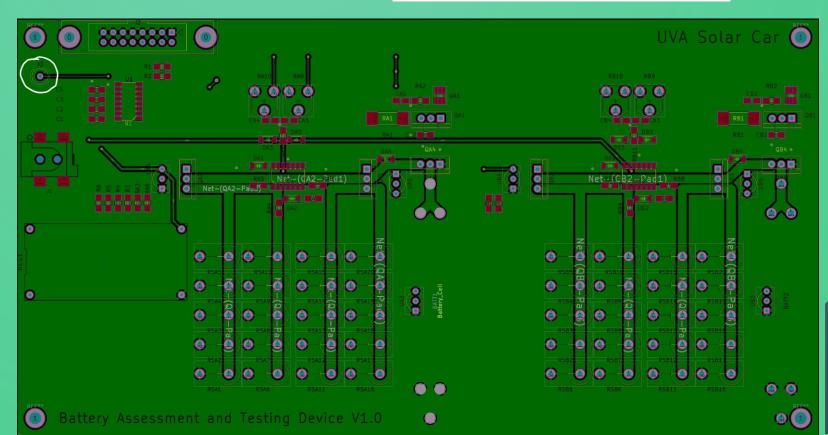


#### STEP 7: CHIP SELECT PIN

This end is soldered in

J3



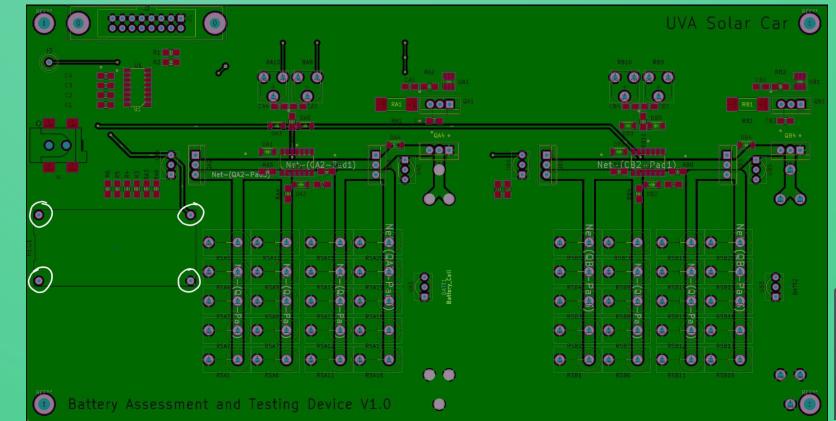


## STEP 8A: BUCK CONVERTER PIN HEADERS

• REG1 (4 pins)

Solder pin headers in first with the longer end sticking up

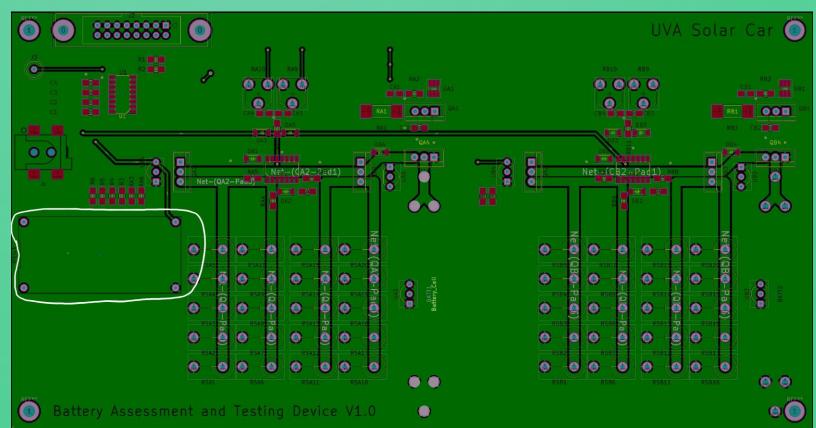




#### STEP 8B: BUCK CONVERTER

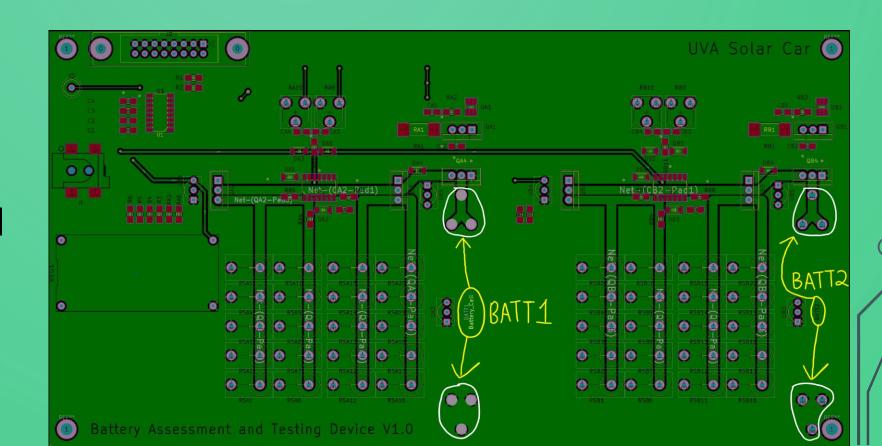
• REG1





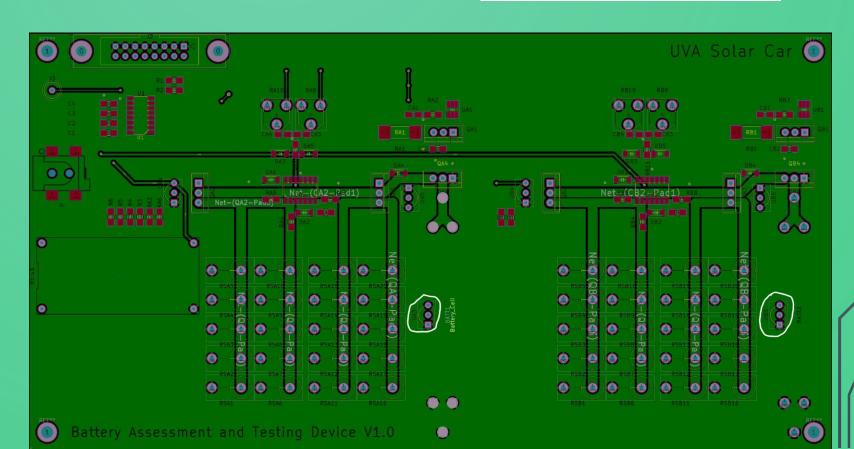
## STEP 9: BATTERY CONTACTS

- BATT1(x2)
- BATT2(x2)





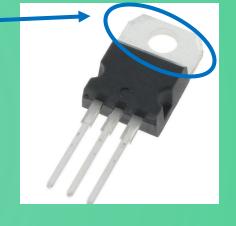
- UA3
- UB3



# STEP 11A: MOSFETS

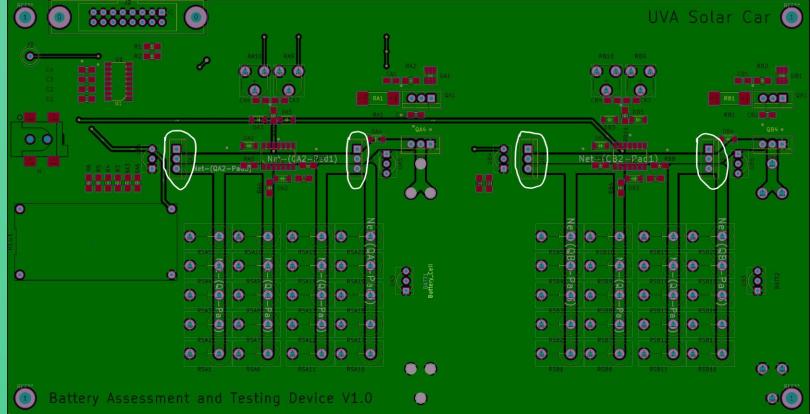
Line up heatsink with this side

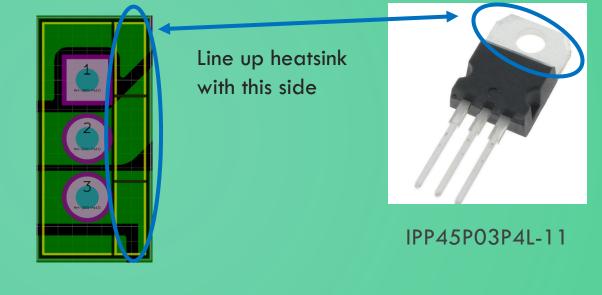
Solder these so that they stick up as high off the board as possible



IRFZ44ZPBF

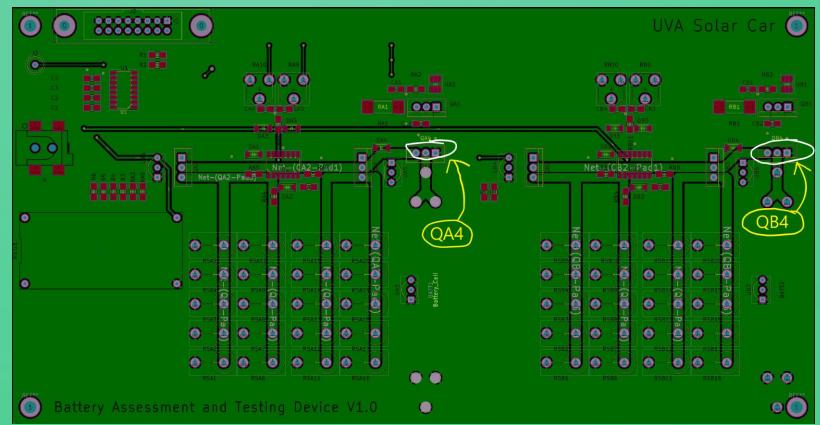
- QA2, QA3
- QB2, QB3





STEP 11B: MOSFETS

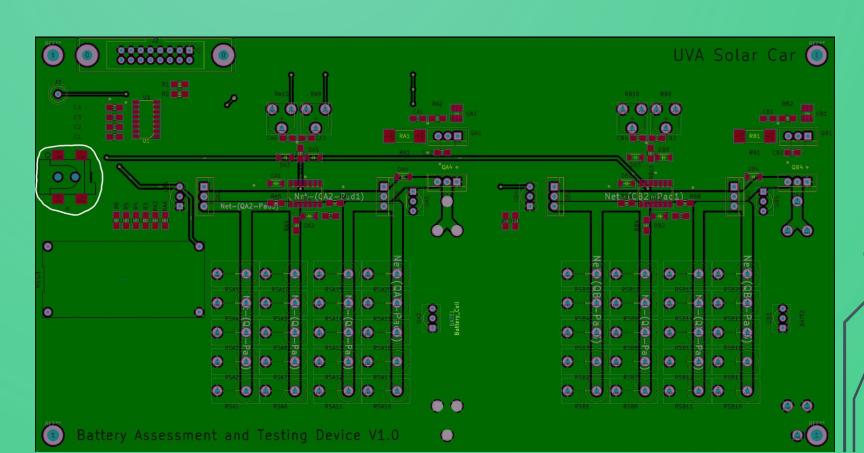
- QA4
- QB4



# STEP 12: DC POWER JACK



J1





Screw heatsinks to MOSFETS

Note: attatch upside down since there are no mounting holes

